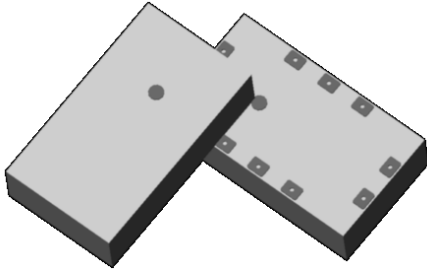


Xinger®

Ultra Low Profile 1608 Balun 50Ω to 50Ω Balanced



Description

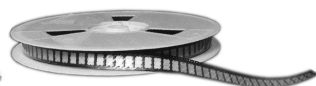
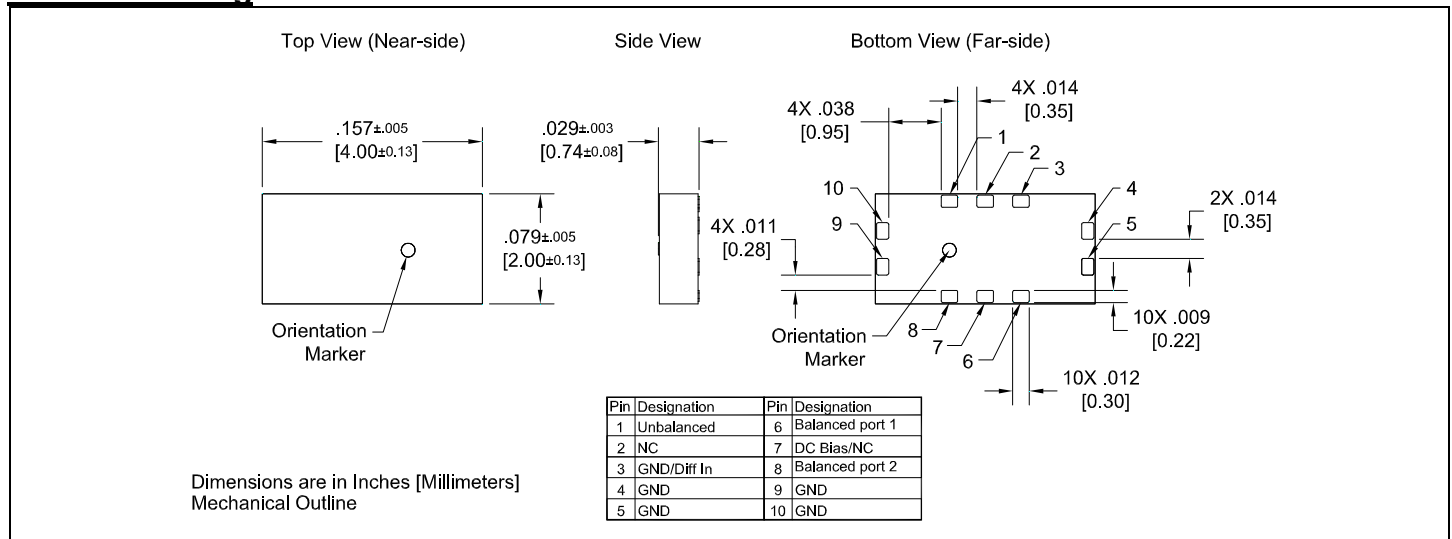
The BD0205F5050A00 is a low profile sub-miniature balanced to unbalanced transformer designed for differential input locations on data conversion devices such as A to D and D to A converters. In an easy to use surface mount package covering 200 MHz to 500 MHz and with CMRR performances over 2x that of the incumbent wire wound products, this transformer is optimized to offer improved SFDR management during operation of the data converter device. The BD0205F5050A00 is ideal for high volume manufacturing and is higher performance and smaller form factor than traditional wire wound transformers. The BD0205F5050A00 has an unbalanced port impedance of 50Ω and a 50Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on the data converter devices. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD0205F5050A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

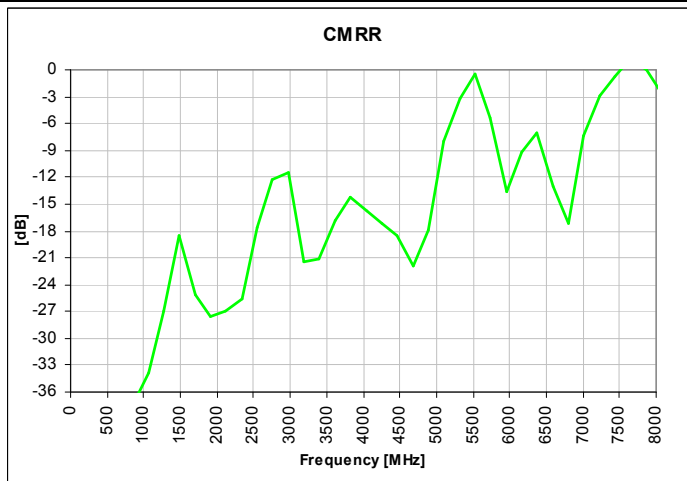
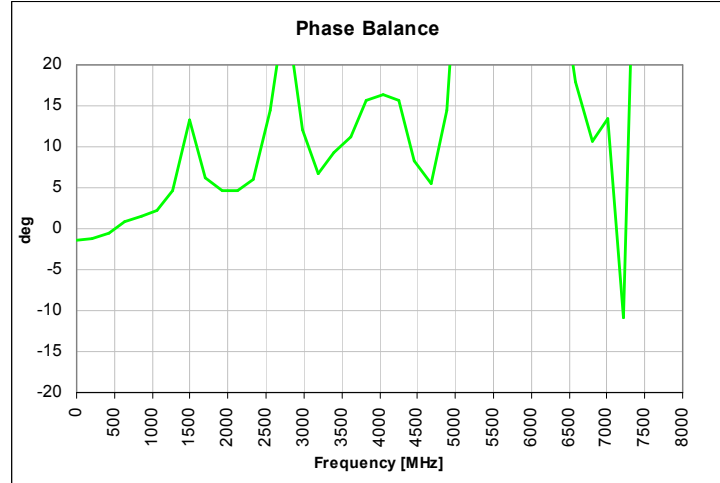
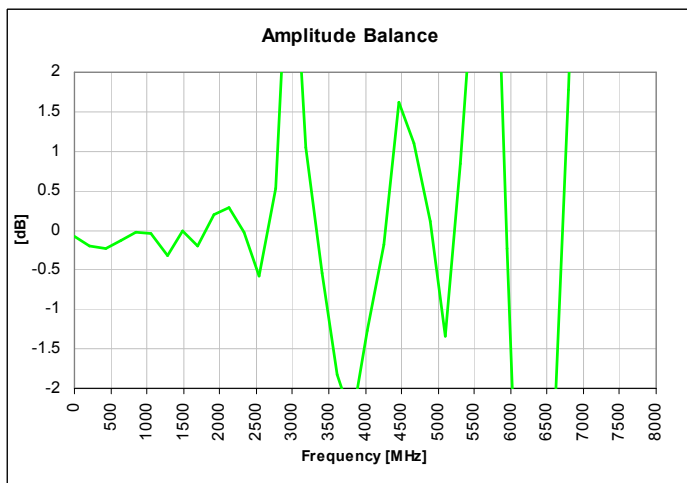
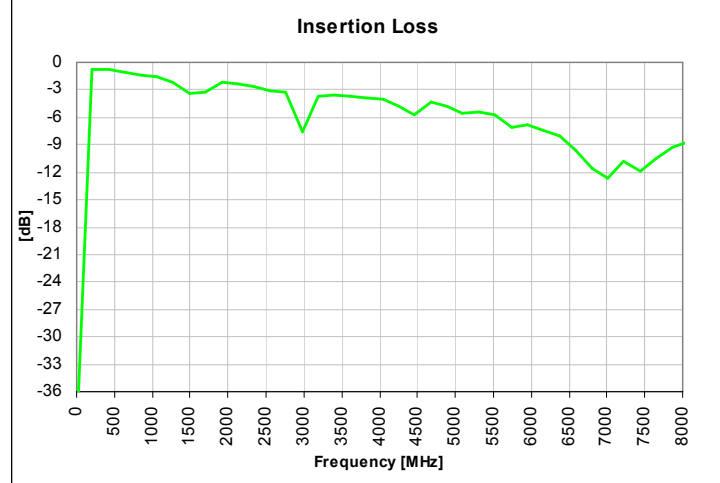
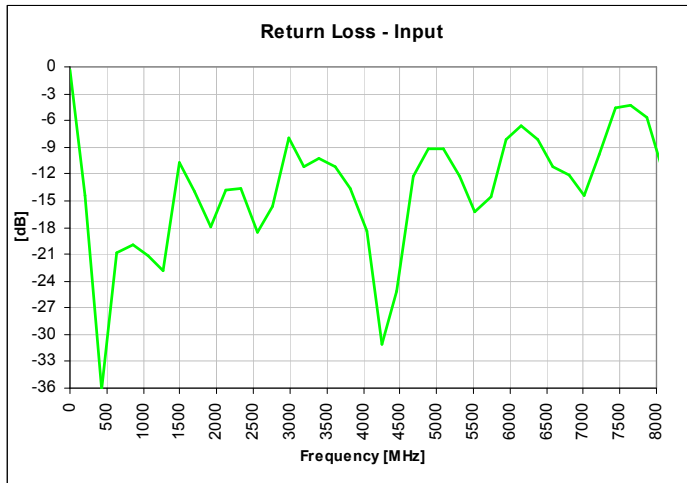
Features:	Parameter	ROOM (25°C)			Unit	
		Min.	Typ.	Max		
<ul style="list-style-type: none"> • 200 – 500 MHz • 0.74 mm Height Profile • 50 Ohm to 2 x 25 Ohm • Excellent CMRR • Input to Output DC Isolation • Surface Mountable • Tape & Reel • Non-conductive Surface • RoHS Compliant • Cascadable • Configurable as UnUn Transformer 	Frequency	200		500	MHz	
	Unbalanced Port Impedance		50		Ω	
	Balanced Port Impedance		50		Ω	
	Return Loss	11	13		dB	
	Insertion Loss*		0.9	1.1	dB	
	Amplitude Balance		0.2	0.6	dB	
	Phase Balance		1	3	Degrees	
	CMRR		36		dB	
	Power Handling			2	Watts	
	Operating Temperature		-55		+85	°C

* Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

Outline Drawing



Typical Broadband Performance: 0 - 8.0 GHz.



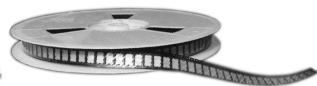
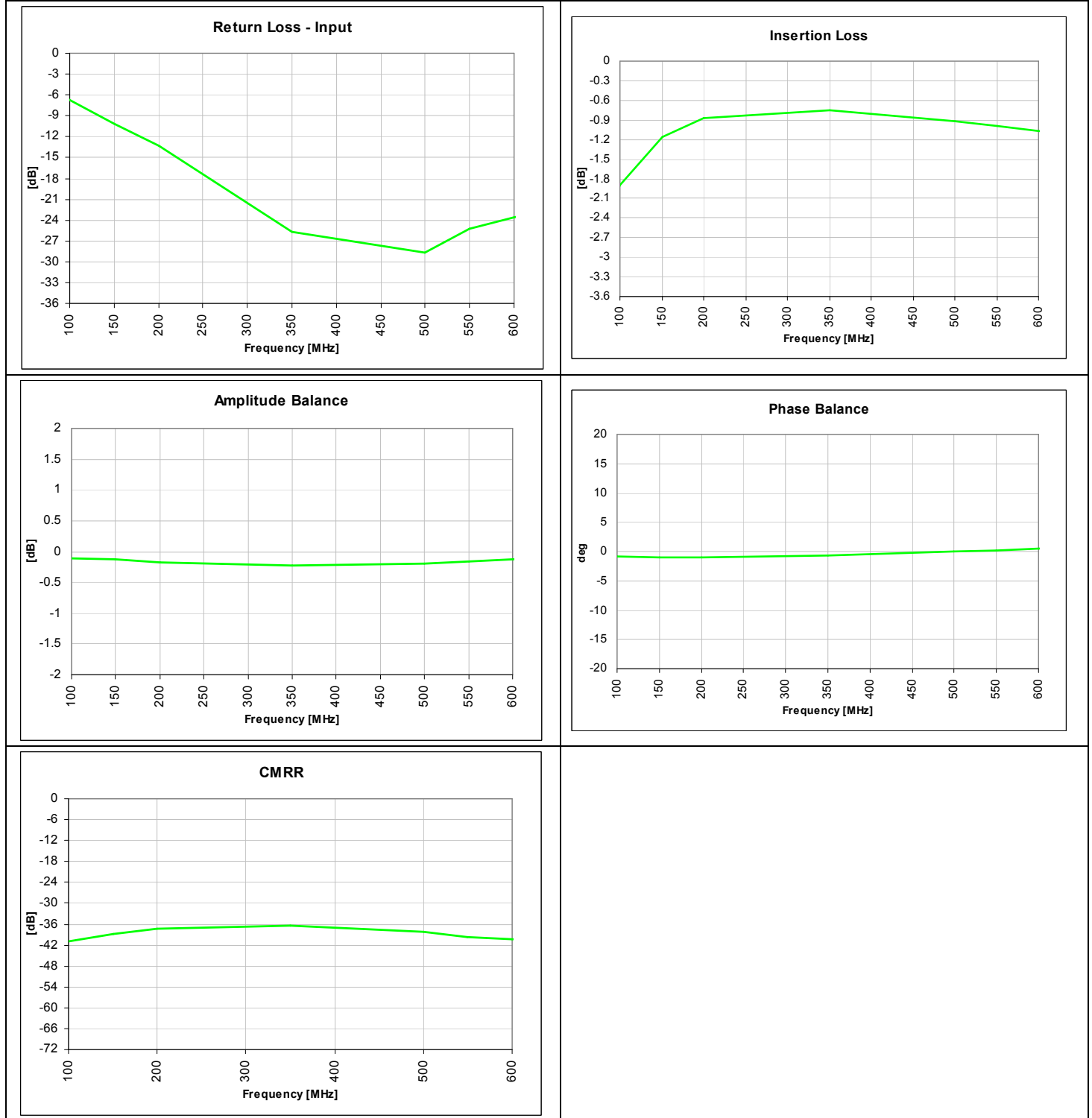
USA/Canada: (315) 432-8909
 Toll Free: (800) 411-6596
 Europe: +44 2392-232392

Available on Tape and Reel for Pick and Place Manufacturing.



Anaren
 What'll we think of next?™

Typical Performance: 100 MHz. to 600 MHz.



Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C.

An example of the PCB footprint used in the testing of these parts is shown below. An example of a DC-biased footprint is also shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.

If desired, DC biasing through the part may be accomplished by the addition of an inductor on Pin #7. Pins #6 and #8 are DC connected to Pin #7. The inductor should be of sufficient value to provide RF isolation on Pin #7.

